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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JANGWON SEO	12/03/2013
YONG HWAN KWON	12/03/2013
JIEUN KIM	12/03/2013
JIHONG KIM	12/03/2013
HYERYUNG KIM	12/03/2013
SERAN JEON	12/03/2013
WOO-SEOK HWANG	12/03/2013

RECEIVING PARTY DATA

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Property Type	Number
Application Number:	29475486

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502669534 REEL: 032159 FRAME: 0378

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Date:	02/06/2014
Total Attachments: 4 source=NewDesApp_D910580144_Assign_ source=NewDesApp_D910580144_Assign_ source=NewDesApp_D910580144_Assign_ source=NewDesApp_D910580144_Assign_	AsFiled#page2.tif AsFiled#page3.tif

PATENT REEL: 032159 FRAME: 0379

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-named inventor, I hereby declare that the	nis declaration is directed to the application attached
hereto, or to United States Application Number or I	PCT International Application Number
filed on	(if applicable), entitled:
DISPLAY SCREEN OR PORTION THER	REOF WITH GRAPHIC USER INTERFACE
The above-identified application was made or author	orized to be made by me.
I believe I am the original inventor or an original joidentified application.	int inventor of a claimed invention in the above-
I hereby acknowledge that any willful false stateme USC 1001 by fine or imprisonment of not more that	•
I have reviewed and understand the contents of the	above-identified application, including the claims.
- · · · · · · · · · · · · · · · · · · ·	ted in 37 CFR 1.56, including for continuation-in-part lable between the filing date of the prior application
ASSIG	NMENT
For valuable consideration, I, as a below-named ass	signor, hereby assign to:
Samsung Electronics Co., Ltd. 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do, 443-742 Republic of Korea	
and its successors and assigns (collectively hereinal	fter called "the Assignee"), the entire right, title, and
interest throughout the world in the inventions and	improvements that are the subject of the application
identified in the above declaration, which is United	States Application Number or PCT International
Application Number 29/475,486	_ filed on _ December 3, 2013
I authorize and request the attorneys appointed in the	ne above-identified application to hereafter complete

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this Assignment by inserting above the application number and the filing date of the above-identified

application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

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